

| L Numb r | Hits | Search Text | DB | Tim stamp |
|---------------------|-------------|--|--------------|-----------------------------|
| 1 | 1 | (makiguichi).inv. | USPAT | 2004/01/11 14:20 |
| 2 | 25 | (makiguchi).inv. | USPAT | 2004/01/11 14:20 |
| - | 3312 | (219/390 or 219/405 or 219/411 or 219/392 or 219/402 or 219/521 or 219/544 or 118/724 or 118/725 or 118/50.1 or 118/500 or 392/416 or 392/418).ccls. and (substrate\$1 or wafer\$1) | USPAT | 2004/01/11 14:20 |
| - | 1337 | ((219/390 or 219/405 or 219/411 or 219/392 or 219/402 or 219/521 or 219/544 or 118/724 or 118/725 or 118/50.1 or 118/500 or 392/416 or 392/418).ccls. and (substrate\$1 or wafer\$1)) and (heat\$3 near8 (support\$1 or holder\$1 or susceptor\$1)) | USPAT | 2004/01/10 18:04 |
| - | 213 | ((219/390 or 219/405 or 219/411 or 219/392 or 219/402 or 219/521 or 219/544 or 118/724 or 118/725 or 118/50.1 or 118/500 or 392/416 or 392/418).ccls. and (substrate\$1 or wafer\$1)) and (heat\$3 near8 (support\$1 or holder\$1 or susceptor\$1))) and (resistive near8 heat\$3) | USPAT | 2004/01/10 18:04 |
| - | 975 | ((219/390 or 219/405 or 219/411 or 219/392 or 219/402 or 219/521 or 219/544 or 118/724 or 118/725 or 118/50.1 or 118/500 or 392/416 or 392/418).ccls. and (substrate\$1 or wafer\$1)) and (heat\$3 near8 plate\$1) | USPAT | 2004/01/10 18:25 |
| - | 453 | ((219/390 or 219/405 or 219/411 or 219/392 or 219/402 or 219/521 or 219/544 or 118/724 or 118/725 or 118/50.1 or 118/500 or 392/416 or 392/418).ccls. and (substrate\$1 or wafer\$1)) and (heat\$3 near8 plate\$1)) and (((upper or top) and (lower or bottom)) near8 plate\$1) | USPAT | 2004/01/10 18:27 |
| - | 382 | ((219/390 or 219/405 or 219/411 or 219/392 or 219/402 or 219/521 or 219/544 or 118/724 or 118/725 or 118/50.1 or 118/500 or 392/416 or 392/418).ccls. and (substrate\$1 or wafer\$1)) and (heat\$3 near8 plate\$1)) and (((upper or top) and (lower or bottom)) near8 plate\$1)) not (((219/390 or 219/405 or 219/411 or 219/392 or 219/402 or 219/521 or 219/544 or 118/724 or 118/725 or 118/50.1 or 118/500 or 392/416 or 392/418).ccls. and (substrate\$1 or wafer\$1)) and (heat\$3 near8 (support\$1 or holder\$1 or susceptor\$1))) and (resistive near8 heat\$3)) | USPAT | 2004/01/10 18:27 |